Kingbright

WP7113LGD

T-1 3/4 (5mm) Solid State Lamp

DESCRIPTION

• The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode

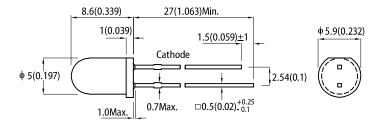
FEATURES

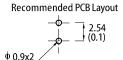
- · Low power consumption
- Popular T-1 3/4 diameter package
- General purpose leads
- Reliable and rugged
- · Long life solid state reliability
- · Available on tape and reel
- · RoHS compliant

APPLICATIONS

- Status indicator
- Illuminator
- Signage applications
- · Decorative and entertainment lighting
- · Commercial and residential architectural lighting

PACKAGE DIMENSIONS





- Notes.

 1. All dimensions are in millimeters (inches).

 2. Tolerance is ±0.25(0.01") unless otherwise noted.

 3. Lead spacing is measured where the leads emerge from the package.

 4. The specifications, characteristics and technical data described in the datasheet are subject to change

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 2mA [2]		Viewing Angle [1]
			Min.	Тур.	201/2
WP7113LGD	■ Green (GaP)	Green Diffused	1.2	3	30°

Notes.

1. e1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		Unit
Parameter			Тур.	Max.	Unit
Wavelength at Peak Emission I _F = 2mA	λ_{peak}	Green	565	-	nm
Dominant Wavelength I _F = 2mA	λ _{dom} ^[1]	Green	568	-	nm
Spectral Bandwidth at 50% Φ REL MAX I_F = 2mA	Δλ	Green	30	-	nm
Capacitance	С	Green	15	-	pF
Forward Voltage I _F = 2mA	V _F ^[2]	Green	1.9	2.25	V
Reverse Current (V _R = 5V)	I _R	Green	-	10	μΑ
Temperature Coefficient of λ_{peak} I _F = 2mA, -10°C \leq T \leq 85°C	TC _{λpeak}	Green	0.1	-	nm/°C
Temperature Coefficient of λ_{dom} I _F = 2mA, -10°C \leq T \leq 85°C	TC_{\lambdadom}	Green	0.06	-	nm/°C
Temperature Coefficient of V_F I_F = 2mA, -10°C \leq T \leq 85°C	TC _V	Green	-2	-	mV/°C

ABSOLUTE MAXIMUM RATINGS at $T_A=25$ °C

Parameter	Symbol	Value	Unit	
Power Dissipation	P _D	62.5	mW	
Reverse Voltage	V _R	5	V	
Junction Temperature	T _j	110	°C	
Operating Temperature	T _{op}	-40 to +85	°C	
Storage Temperature	T _{stg}	-40 to +85	°C	
DC Forward Current	I _F	25	mA	
Peak Forward Current	I _{FM} ^[1]	140	mA	
Electrostatic Discharge Threshold (HBM)	-	8000	V	
Thermal Resistance (Junction / Ambient)	R _{th JA} [2]	590	°C/W	
Thermal Resistance (Junction / Solder point)	R _{th JS} [2]	460	°C/W	
Lead Solder Temperature [3]		260°C For 3 Seconds		
Lead Solder Temperature [4]		260°C For 5 Seconds		

Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. R_{IN,JA}, R_{IN,S} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).

3. 2mm below package base.

4. Smm below package base.

5. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.



^{1.} The dominant wavelength (\(\lambda\)) above is the setup value of the sorting machine. (Tolerance \(\lambda\)d:\(\pm\)1nm.\)
2. Forward voltage: \(\pm\)20. 10. 10. 3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.